

October 2013

GBPC 12, 15, 25, 35 SERIES Bridge Rectifiers (Glass Passivated)

Features

- Integrally molded heat-sink provided very low thermal resistance for maximum heat dissipation.
- Surge Overload Ratings from 300 A to 400 A.
- Isolated voltage from case to lead over 2500 V.
- UL certified, UL #E258596
- Terminals Finish Material Silver (Solderable per MIL-STD-202, Method 208 for the wire type GBPC-W package)
 Nickel for GBPC package.

Suffix "W"

• Wire Lead Structure

Suffix "M"

• Terminal Location Face to Face









GBPC-W



Ordering Informations

Part Number	Marking	Package	Packing Method			
GBPC12005	GBPC12005					
GBPC1201	GBPC1201					
GBPC1202	GBPC1202					
GBPC1204	GBPC1204					
GBPC1206	GBPC1206					
GBPC1208	GBPC1208					
GBPC1210	GBPC1210					
GBPC15005	GBPC15005					
GBPC1501	GBPC1501					
GBPC1502	GBPC1502					
GBPC1504	GBPC1504					
GBPC1506	GBPC1506					
GBPC1508	GBPC1508					
GBPC1510	GBPC1510	CDDC 41				
GBPC25005	GBPC25005	GBPC 4L				
GBPC2501	GBPC2501					
GBPC2502	GBPC2502					
GBPC2504	GBPC2504					
GBPC2506	GBPC2506					
GBPC2508	GBPC2508		Dulle			
GBPC2510	GBPC2510		Bulk			
GBPC35005	GBPC35005					
GBPC3501	GBPC3501					
GBPC3502	GBPC3502					
GBPC3504	GBPC3504					
GBPC3506	GBPC3506					
GBPC3508	GBPC3508					
GBPC3510	GBPC3510					
GBPC1201W	GBPC1201W					
GBPC1202W	GBPC1202W					
GBPC1204W	GBPC1204W					
GBPC1206W	GBPC1206W					
GBPC1208W	GBPC1208W					
GBPC1210W	GBPC1210W	ODDO W 41				
GBPC15005W	GBPC15005W	GBPC-W 4L				
GBPC1501W	GBPC1501W					
GBPC1502W	GBPC1502W					
GBPC1504W	GBPC1504W					
GBPC1506W	GBPC1506W					
GBPC1508W	GBPC1508W					

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Ordering Informations (continued)

Part Number	Marking	Package	Packing Method
GBPC1510W	GBPC1510W		
GBPC25005W	GBPC25005W		
GBPC2501W	GBPC2501W		
GBPC2502W	GBPC2502W		
GBPC2504W	GBPC2504W		
GBPC2506W	GBPC2506W		
GBPC2508W	GBPC2508W		
GBPC2510W	GBPC2510W	GBPC-W 4L	Bulk
GBPC35005W	GBPC35005W		
GBPC3501W	GBPC3501W		
GBPC3502W	GBPC3502W		
GBPC3504W	GBPC3504W		
GBPC3506W	GBPC3506W		
GBPC3508W	GBPC3508W		
GBPC3510W	GBPC3510W		

Absolute Maximum Ratings(1)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter		Value						Units			
Symbol			005	01	02	04	06	08	10	Units		
V _{RRM}	Maximum Repetitive Reverse Volt	age	50	100	200	400	600	800	1000	V		
V _{RMS}	Maximum RMS Bridge Input Volta	ge	35	70	140	280	420	560	700	V		
V_{R}	DC Reverse Voltage (Rated V _R)		50	100	200	400	600	800	1000	V		
		GBPC12				12						
	Average Rectified Forward	GBPC15	15						A			
I _{F(AV)}	Current at T _C = 55°C	GBPC25	25									
			35									
I _{FSM}	Non-Repetitive Peak Forward Surge Current	GBPC12, 15, 25	300					Α				
	8.3ms Single Half-Sine-Wave GBF		400						Α			
T _{STG}	Storage Temperature Range		-55 to +150						°C			
TJ	Operating Junction Temperature		-55 to +150						°C			

Note:

1. These ratings are limiting values above which the serviceability of any semiconductor device may by impaired.

Thermal Characteristics

Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Value	Units
P _D	Power Dissipation	83.3	W
$R_{\theta JC}$	Thermal Resistance, Junction to Case ⁽²⁾	1.5	°C/W

Note:

2. With Heatsink.

Electrical Characteristics

Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Test Conditions			Value	Units
	Forward Voltage Drop, per bridge	6.0 A	GB	PC12		V
W		7.5 A	GB	PC15	1.1 (Mov)	
V _F		12.5 A	GB	PC25	1.1 (Max)	
		17.5 A	GB	PC35		
/ ₁	Poverse Current per element at Bated //	T _A = 25°C			5.0 (Max)	μΑ
I _R	Reverse Current, per element at Rated V _R	T _A = 125°C			500 (Max)	μΑ
l ² t	Poting for Euging t a 9.25 mg	GBPC12	GBPC12, 15, 25		375	A ² Sec
1-1	Rating for Fusing t < 8.35 ms	GBPC35			660	A ² Sec
	Total Capacitance, per leg	GBPC12, 15, 25			180	pF
C _T	$V_R = 4.0 \text{ V}$ f = 1.0 MHz	GBPC35			200	pF

Typical Performance Characteristics

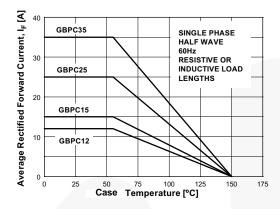


Figure 1. Forward Current Derating Curve

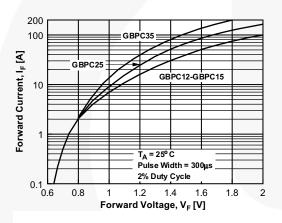


Figure 3. Forward Voltage Characteristics

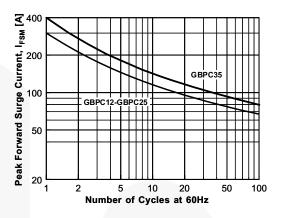


Figure 2. Non-Repetitive Surge Current

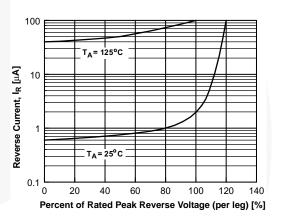


Figure 4. Reverse Current vs. Reverse Voltage

Physical Dimension GBPC GBPC STYLE 17.600 15.500 11.23 10.97 0.91 0.71 (4X) $(\emptyset 2.39) 2X$ $\oplus \Phi$ (Ø3.41) 2X 15.30 29.00 13.30 28.50 $\bigoplus \Phi$ 6.35 MAX 24.50 21.50 (4X) 19.10 17.10 29.00 28.50 **GBPC-W STYLE** $\phi_{0.97}^{1.07}$ (4X) 11.23 10.97 Ø 5.590 5.080 19.10 29.00 17.10 28.50 19.10 17.10 30.50 MIN -29.00 28.50 NOTES:

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 D. FAIRCHILDSEMICONDUCTOR
 E. DRAWING FILE NAME: MKT-GBPC04A REV3

Figure 5. 4-TERMINAL, COMBINATION GBPC AND GBPC-W (ACTIVE)

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Definition of Terms		
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